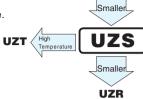
• Chip type with 4.5mm height.

4.5mmL Chip Type





- Designed for surface mounting on high density PC board. • Applicable to automatic mounting machine fed with carrier tape.
- Compliant to the RoHS directive (2011/65/EU,(EU)2015/863).
- AEC-Q200 compliant. Please contact us for details.



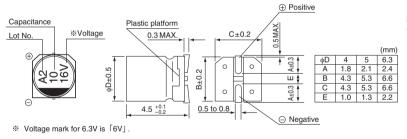
**UWX** 



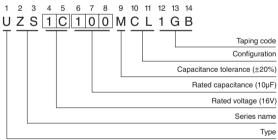
## ■Specifications

Item	Performance Characteristics													
Category Temperature Range	-40 to +85°C													
Rated Voltage Range	4 to 50V													
Rated Capacitance Range	1 to 220µF													
Capacitance Tolerance	±20% at 120Hz, 20°C													
Leakage Current	After 2 minutes' application of rated voltage at 20°C, leakage current is not more than 0.01 CV or 3 (μA) ,whichever is greater.													
Tangent of loss angle (tan δ)								Measurement frequency: 120H				Hz at 20°C		
	Rated voltage (V)		4		6.3		0	16	25		35	50		
	tan δ (M	tan δ (MAX.)		0 (	0.30		24	0.19	0.16	5	0.14	0.14		
	Measurement frequency : 120Hz													
O. 1. 171	Rated voltage (V)			4 6		3	10	16	2	25	35	50		
Stability at Low Temperature	Impedance ratio	Z-25°C / Z-	-20°C	7	4		3	2		2	2	2		
	ZT / Z20 (MAX.)	Z-40°C / Z-	-20°C	15	8		8	4		4	3	3		
Endurance	The specifications listed at right shall be met when Capa						eitance change Within ±20% of the initial capacitance value				ue			
	the capacitors are restored to 20°C after the rated $\tan \delta$					200% or less than the initia			itial specified valu	ie				
							ge current Less than or equal to the initial specified value				alue			
Shelf Life	After storing the capacitors under no load at 85°C for 1000 hours and then performing voltage treatment based on JIS C 5101-4 clause 4.1 at 20°C, they shall meet the specified values for the endurance characteristics listed above.													
Resistance to soldering heat	The capacitors are kept on a hot plate for 30 seconds, which is							Capaci	Capacitance change Within ±10% of the initial capacitance va				nce value	
	maintained at 250°C. The capacitors shall meet the characteristic requirements listed at right when they are removed from the plate and restored to 20°C.						tan δ			Less than or equal to the initial specified value				
							Leakage current			Less than or equal to the initial specified value				
Marking	Black print on the case top.													

## ■Chip Type



## Type numbering system (Example: 16V 10µF)



Frequency coefficient of rated ripple current

- 1 7			1. 1		
Frequency	50 Hz	120 Hz	300 Hz	1 kHz	10 kHz or more
Coefficient	0.70	1.00	1 17	1.36	1 50



## Dimensions

Rated Voltage (V) (code)	Rated Capacitance (µF)	Case Size φD×L(mm)	tan δ	Leakage Current (µA) (at 20°C after 2 minutes	Rated Ripple (mArms) (85°C/120Hz)	Part Number
	33	4×4.5	0.50	3	28	UZS0G330MCL1GB
4	47	4×4.5	0.50	3	33	UZS0G470MCL1GB
(0G)	100	5×4.5	0.50	4	56	UZS0G101MCL1GB
	220	6.3×4.5	0.50	8.8	96	UZS0G221MCL1GB
	22	4×4.5	0.30	3	28	UZS0J220MCL1GB
6.3	33	5×4.5	0.30	3	37	UZS0J330MCL1GB
(OJ)	47	5×4.5	0.30	3	45	UZS0J470MCL1GB
	100	6.3×4.5	0.30	6.3	70	UZS0J101MCL1GB
	22	5×4.5	0.24	3	33	UZS1A220MCL1GB
10 (1A)	33	5×4.5	0.24	3.3	41	UZS1A330MCL1GB
(117)	47	6.3×4.5	0.24	4.7	52	UZS1A470MCL1GB
	10	4×4.5	0.19	3	23	UZS1C100MCL1GB
16	22	5×4.5	0.19	3.52	37	UZS1C220MCL1GB
(1C)	33	6.3×4.5	0.19	5.28	49	UZS1C330MCL1GB
	47	6.3×4.5	0.19	7.52	58	UZS1C470MCL1GB
	4.7	4×4.5	0.16	3	16	UZS1E4R7MCL1GB
25	10	5×4.5	0.16	3	27	UZS1E100MCL1GB
(1E)	22	6.3×4.5	0.16	5.5	42	UZS1E220MCL1GB
	33	6.3×4.5	0.16	8.25	52	UZS1E330MCL1GB
	4.7	4×4.5	0.14	3	18	UZS1V4R7MCL1GB
35 (1V)	10	5×4.5	0.14	3.5	29	UZS1V100MCL1GB
	22	6.3×4.5	0.14	7.7	46	UZS1V220MCL1GB
	1	4×4.5	0.14	3	8.4	UZS1H010MCL1GB
	2.2	4×4.5	0.14	3	13	UZS1H2R2MCL1GB
50 (1H)	3.3	4×4.5	0.14	3	17	UZS1H3R3MCL1GB
	4.7	5×4.5	0.14	3	20	UZS1H4R7MCL1GB
	10	6.3×4.5	0.14	5	33	UZS1H100MCL1GB

<sup>•</sup> For taping specifications, recommended land size/soldering by reflow and minimum order quantity, please refer to the Guidelines for Aluminum Electrolytic Capacitors.

• Please select UUR, UUG if high C/V products are required.